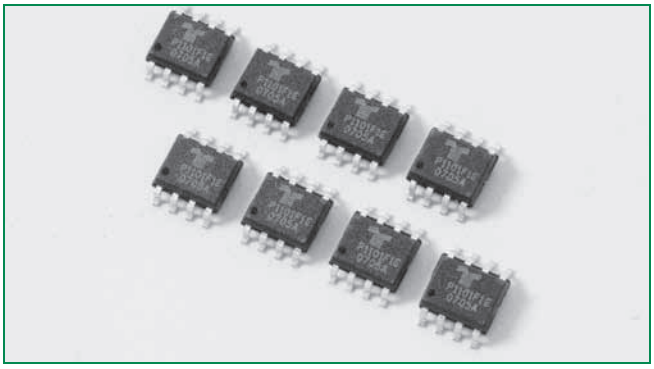
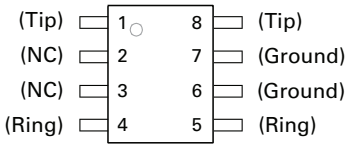
RoHS Fixed Voltage Enhanced Single Port Series - MS-012



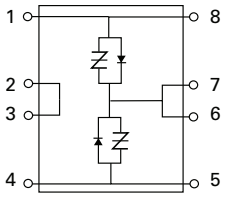
Agency Approvals

Agency	Agency File Number
UL	E133083

Pinout



Schematic Symbol



Description

The MS-012 packaged Fixed Voltage Enhanced Single Port Series are SIDACtor® devices designed to protect sensitive SLICs (Subscriber Line Interface Circuit) from damaging overvoltage transients.

The series provides single port protection using a fixed voltage switching device for negative surges. Positive surges are routed though enhanced switching diodes to a ground reference. The series is also pin-to-pin compatible to industry standard programmable SO-8 SLIC protectors.

Features & Benefits

- Integrated fast switching diodes for positive voltage surges
- Single port protection in one package
- Low voltage overshoot
- Low on-state voltage
- Does not degrade with use
- Fails short circuit when surged in excess of ratings
- Pin-to-pin SO-8 compatible footprint

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level
- ITU K.20/21 Basic Level
- GR 1089 Inter-building*
- GR 1089 Intra-building*
- IEC 61000-4-5
- YD/T 1082
- YD/T 993
- YD/T 950

* Series resistance required

Electrical Characteristics

Part Number	Marking	V_{DRM} @ I_{DRM}=5µA	V_S @ 100V/µs	I_H	I_S	I_T @ V_T	V_T @ I_T=1 Amps	V_F @ 25°	Capacitance
		V min	V max	mA min	mA max	A max	V max	V max	
P0641DF-1E	P0641F1E	58	77	150	800	1	5	5	See Capacitance Values Table
P0721DF-1E	P0721F1E	65	88	150	800	1	5	5	
P0901DF-1E	P0901F1E	75	98	150	800	1	5	5	
P0991DF-1E	P0991F1E	80	104	150	800	1	5	5	
P1001DF-1E	P1001F1E	85	110	150	800	1	5	5	
P1101DF-1E	P1101F1E	95	130	150	800	1	5	5	
P1301DF-1E	P1301F1E	120	160	150	800	1	5	5	
P1701DF-1E	P1701F1E	160	200	150	800	1	5	5	

Notes:
- Absolute maximum ratings measured at T_A= 25°C (unless otherwise noted).
- Devices are uni-directional
- All electrical characteristics shown are defined from Tip (pins 1 & 8) to Ground (pins 6 & 7), and Ring (pins 4 & 5) to ground (pins 6 & 7)
- V_F < 8.5 volts @ 10 x 700µs, 37.5 Amps

Capacitance Values

Part Number	pF Pin 1,8-6,7 / 4,5-6,7 Tip-Ground, Ring-Ground		pF Pin 1,8-4,5 Tip-Ring	
	MIN	MAX	MIN	MAX
P0641DF-1E	40	90	20	45
P0721DF-1E	35	85	20	45
P0901DF-1E	30	80	20	40
P0991DF-1E	25	75	15	35
P1001DF-1E	25	75	15	35
P1101DF-1E	25	70	15	30
P1301DF-1E	20	70	15	30
P1701DF-1E	20	70	15	30

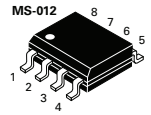
Note: Off-state capacitance (C_O) is measured at 1 MHz with a 2 V bias.

Surge Ratings

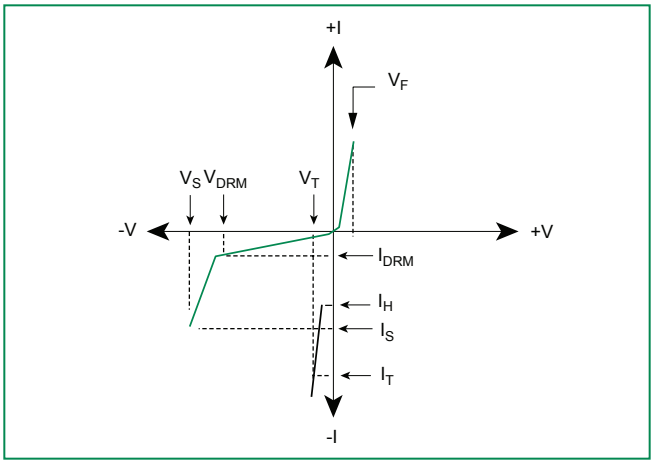
Series	I_{PP}				I_{TSM}	di/dt
	2x10µs	1.2x50µs/8x20µs	10x700/5x310µs	10x1000µs	600V_{RMS} 1s	
	A min	A min	A min	A min	A min	Amps/µs max
F	120	100	50	30	1	500

Notes:
- Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product.
- I_{PP} ratings applicable over temperature range of -40°C to +85°C
- The device must initially be in thermal equilibrium with -40°C ≤ T_J ≤ +150°C

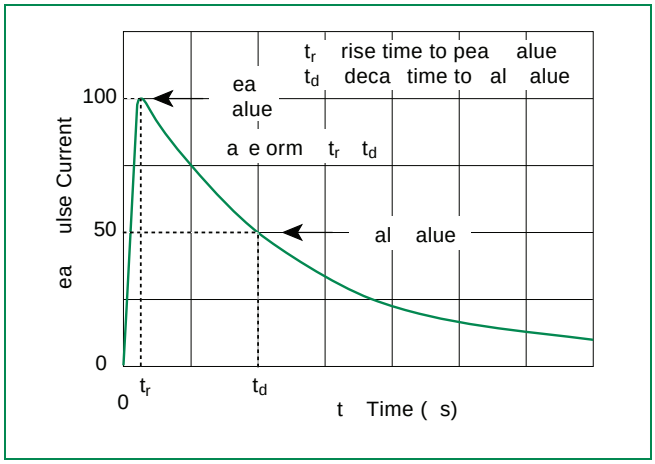
Thermal Considerations

Package	Symbol	Parameter	Value	Unit
	T_J	Operating Junction Temperature Range	-40 to +150	°C
	T_S	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	120	°C/W

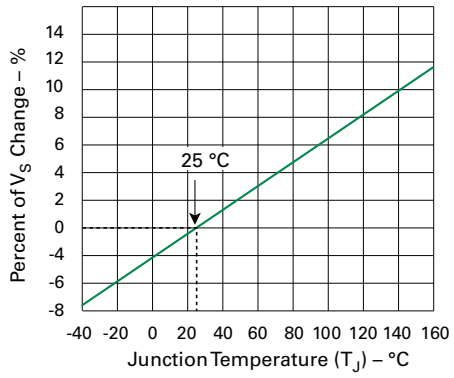
V-I Characteristics



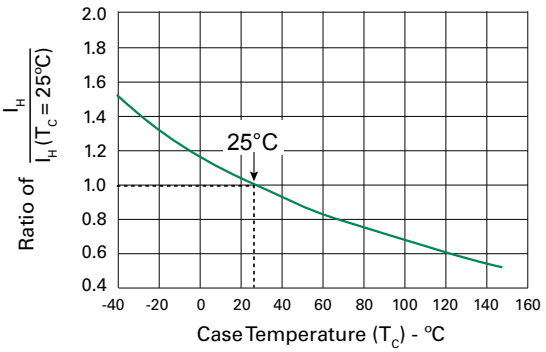
t_r x t_d Pulse Waveform



Normalized V_S Change vs. Junction Temperature



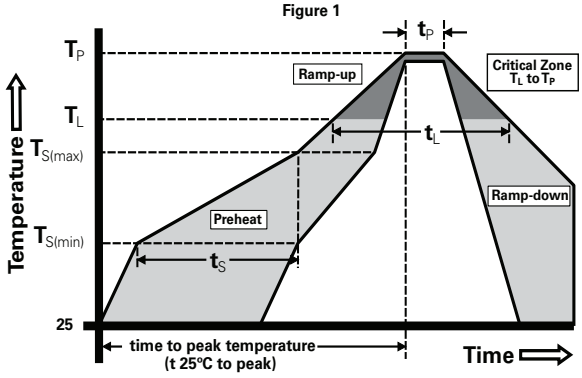
Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

Reflow Condition		Pb-Free assembly (see Fig. 1)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max ($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max.
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	-Temperature (T_L) (Liquidus)	+217°C
	-Temperature (t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp (T_P)		8 min. Max.
Do not exceed		+260°C

Figure 1



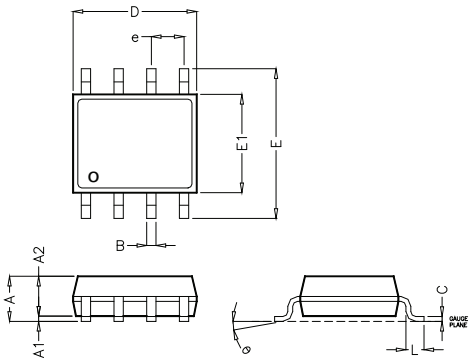
Physical Specifications

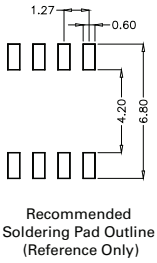
Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0

Environmental Specifications

High Temp Voltage Blocking	80% Rated V_{DRM} (V_{DC}) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

Dimensions — MS-012





Recommended Soldering Pad Outline (Reference Only)

Dimension	Inches		Millimeters	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
A2	0.043	0.065	1.25	1.65
B	0.012	0.020	0.31	0.51
C	0.007	0.010	0.17	0.25
D	0.189	0.197	4.80	5.00
E	0.228	0.244	5.80	6.20
E1	0.150	0.157	3.80	4.00
e	0.050 BSC*		1.27 BSC*	
L	0.016	0.050	0.40	1.27

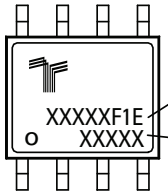
* BSC = **B**asic **S**pacing between **C**enters

Part Numbering

Pxxx **1** **DF** -**1E**

- **TYPE** — **P:** SIDACtor
- **MEDIAN VOLTAGE**
- **CONSTRUCTION VARIABLE**
- **SINGLE ENHANCED**
- **I_{PP} RATING**
- **PACKAGE TYPE**

Part Marking



Part Number Code
(Refer to Electrical Characteristics Table)

Date Code

Packing Options

Package Type	Description	Quantity	Added Suffix	Industry Standard
D	MS-012 SMT 8-pin SOIC Tape and Reel Pack	2500	N/A	EIA-481-D

Tape and Reel Specifications — MS-012